

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Kiang-Giap Lau</td> <td>05/17/2012</td> </tr> <tr> <td>Kheng-Chong Tan</td> <td>05/17/2012</td> </tr> </tbody> </table>		Name	Execution Date	Kiang-Giap Lau	05/17/2012	Kheng-Chong Tan	05/17/2012
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Kiang-Giap Lau	05/17/2012						
Kheng-Chong Tan	05/17/2012						
RECEIVING PARTY DATA							
Name:	PHISON ELECTRONICS CORP.						
Street Address:	No. 1, Qun Yi Rd., Jhunan,						
City:	Miaoli						
State/Country:	TAIWAN						
Postal Code:	350						
PROPERTY NUMBERS Total: 1							
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13479290</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13479290		
Property Type	Number						
Application Number:	13479290						
CORRESPONDENCE DATA							
Fax Number:	(510)580-7280						
Email:	usa@jcipgroup.com.tw						
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Address Line 4:	TAIPEI, TAIWAN 100						
ATTORNEY DOCKET NUMBER:	39329-US-PA						
NAME OF SUBMITTER:	Belinda Lee						
Total Attachments: 2 source=39329us_assgn#page1.tif source=39329us_assgn#page2.tif							

CH \$40.00 13479290

ASSIGNMENT

WHEREAS,

1. Kiang-Giap Lau

2. Kheng-Chong Tan

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **DATA MERGING METHOD FOR NON-VOLATILE MEMORY MODULE,
AND MEMORY CONTROLLER AND MEMORY STORAGE DEVICE USING
THE SAME**

[] Filed: Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, PHISON ELECTRONICS CORP.

of No. 1, Qun Yi Rd., Jhunan, Miaoli, Taiwan 350, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

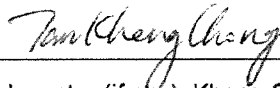
Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: 
Sole or First Joint Inventor: Kiang-Giap Lau

Date: 2012-5-17

Signature: 
Second Joint Inventor (if any): Kheng-Chong Tan

Date: 2012-5-17